

IRLML2502PbF

Ultra Low On-Resistance

- N-Channel MOSFET
- SOT-23 Footprint
- Low Profile (<1.1mm)
- Available in Tape and Reel
- Fast Switching
- Lead-Free
- RoHS Compliant, Halogen-Free

HEXFET® Power MOSFET G [1 3 D

$V_{DSS} = 20V$

 $R_{DS(on)} = 0.045\Omega$

Description

These N-Channel MOSFETs from International Rectifier utilize advanced processing techniques to achieve extremely low onresistance per silicon area. This benefit, combined with the fast switching speed and ruggedized device design that HEXFET® power MOSFETs are well known for, provides the designer with an extremely efficient and reliable device for use in battery and load management.

A thermally enhanced large pad leadframe has been incorporated into the standard SOT-23 package to produce a HEXFET Power MOSFET with the industry's smallest footprint. This package, dubbed the Micro3™, is ideal for applications where printed circuit board space is at a premium. The low profile (<1.1mm) of the Micro3 allows it to fit easily into extremely thin application environments such as portable electronics and PCMCIA cards. The thermal resistance and power dissipation are the best available.



		Standard Pa	ck	
Base Part Number	Package Type	Form	Quantity	Orderable Part Number
IRLML2502TRPbF	Micro3™ (SOT-23)	Tape and Reel	3000	IRLML2502TRPbF

Absolute Maximum Ratings

	Parameter	Max.	Units
V _{DS}	Drain- Source Voltage	20	V
I _D @ T _A = 25°C	Continuous Drain Current, V _{GS} @ 4.5V	4.2	
I _D @ T _A = 70°C	Continuous Drain Current, V _{GS} @ 4.5V	3.4	Α
I _{DM}	Pulsed Drain Current ①	33	1
P _D @T _A = 25°C	Power Dissipation	1.25	W
P _D @T _A = 70°C	Power Dissipation	0.8] VV
	Linear Derating Factor	0.01	W/°C
V _{GS}	Gate-to-Source Voltage	± 12	V
T _{J,} T _{STG}	Junction and Storage Temperature Range	-55 to + 150	°C

Thermal Resistance

	Parameter	Тур.	Max.	Units
$R_{\theta JA}$	Maximum Junction-to-Ambient®	75	100	°C/W



Electrical Characteristics @ T_J = 25°C (unless otherwise specified)

	Parameter	Min.	Тур.	Max.	Units	Conditions
V _{(BR)DSS}	Drain-to-Source Breakdown Voltage	20			V	$V_{GS} = 0V, I_{D} = 250uA$
$\Delta V_{(BR)DSS}/\Delta T_{J}$	Breakdown Voltage Temp. Coefficient		0.01		V/°C	Reference to 25°C, I _D = 1.0mA
R _{DS(on)}	Static Drain-to-Source On-Resistance		0.035	0.045	Ω	V _{GS} = 4.5V, I _D = 4.2A ⊘
			0.050	0.080		V _{GS} = 2.5V, I _D = 3.6A ②
V _{GS(th)}	Gate Threshold Voltage	0.60		1.2	٧	V V I 050A
$\Delta V_{GS(th)}$	Gate Threshold Voltage Coefficient		-3.2		mV/°C	$V_{DS} = V_{GS}, I_D = 250\mu A$
gfs	Forward Transconductance	5.8			S	$V_{DS} = 10V, I_{D} = 4.0A$
DSS	Drain-to-Source Leakage Current			1.0		$V_{DS} = 16V, V_{GS} = 0V$
				25	μA	$V_{DS} = 16V, V_{GS} = 0V, T_{J} = 70^{\circ}C$
GSS	Gate-to-Source Forward Leakage			100	nA	V _{GS} = 12V
	Gate-to-Source Reverse Leakage			-100		V _{GS} = -12V
Q _q	Total Gate Charge	_	8.0	12		I _D = 4.0A
Q_{as}	Gate-to-Source Charge		1.8	2.7	nC	V _{DS} = 10V
Q_{gd}	Gate-to-Drain ("Miller") Charge		1.7	2.6		V _{GS} = 5.0V ∅
t _{d(on)}	Turn-On Delay Time		7.5			V _{DD} = 10V
r	Rise Time		10			I _D = 1.0A
t _{d(off)}	Turn-Off Delay Time		54		ns	$R_G = 6\Omega$
t _f	Fall Time		26			R _D = 10Ω ②
C _{iss}	Input Capacitance		740			V _{GS} = 0V
Coss	Output Capacitance		90	_	pF	V _{DS} = 15V
C _{rss}	Reverse Transfer Capacitance		66			f = 1.0 MHz

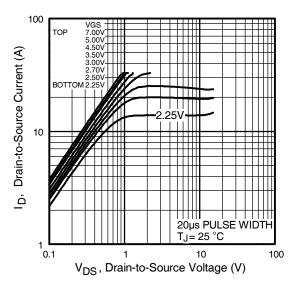
Source-Drain Rating and Characteristics

	Parameter	Min.	Тур.	Max.	Units	Conditions
Is	Continuous Source Current			1.3		MOSFET symbol
	(Body Diode)			1.0	Α	showing the
I _{SM}	Pulsed Source Current			33		integral reverse
	(Body Diode) ①			- 33		p-n junction diode.
V_{SD}	Diode Forward Voltage			1.2	٧	$T_J = 25^{\circ}C, I_S = 1.3A, V_{GS} = 0V \oslash$
t _{rr}	Reverse Recovery Time		16	24	ns	T _J = 25°C, I _F = 1.3A
Q _{rr}	Reverse Recovery Charge		8.6	13	nC	di/dt = 100A/µs ⊘

Notes:

- ① Repetitive rating; pulse width limited by max. junction temperature. (See fig. 11)
- ② Pulse width \leq 300 μ s; duty cycle \leq 2%.

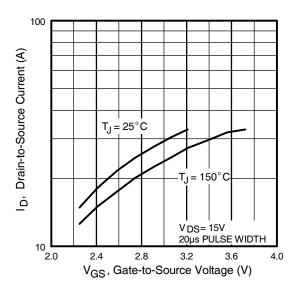




TOP VGS 7,00V 4,50V 4,50V 3,50V 2,70V 2,70

Fig 1. Typical Output Characteristics

Fig 2. Typical Output Characteristics



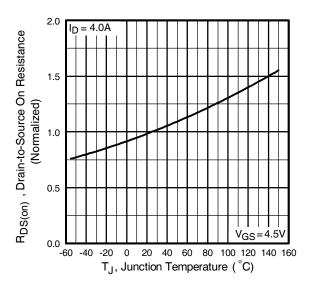


Fig 3. Typical Transfer Characteristics

Fig 4. Normalized On-Resistance Vs. Temperature



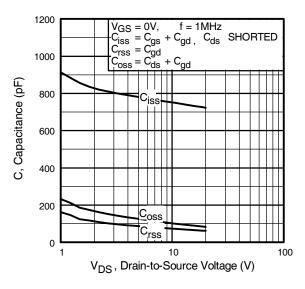


Fig 5. Typical Capacitance Vs. Drain-to-Source Voltage

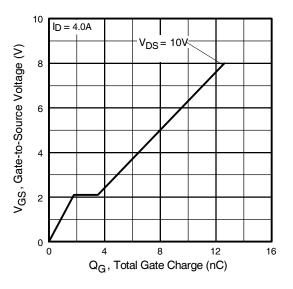


Fig 6. Typical Gate Charge Vs. Gate-to-Source Voltage

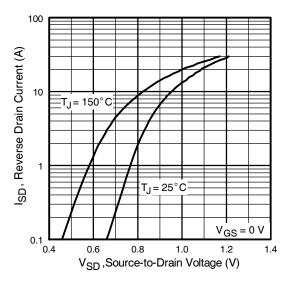


Fig 7. Typical Source-Drain Diode Forward Voltage

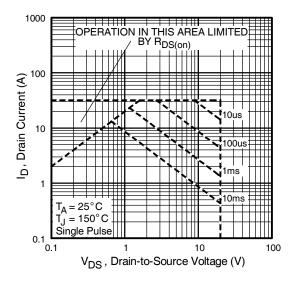


Fig 8. Maximum Safe Operating Area



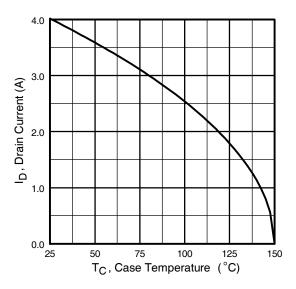


Fig 9. Maximum Drain Current Vs. Case Temperature

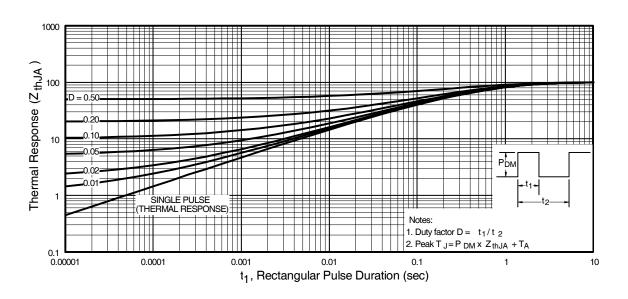


Fig 10. Maximum Effective Transient Thermal Impedance, Junction-to-Ambient

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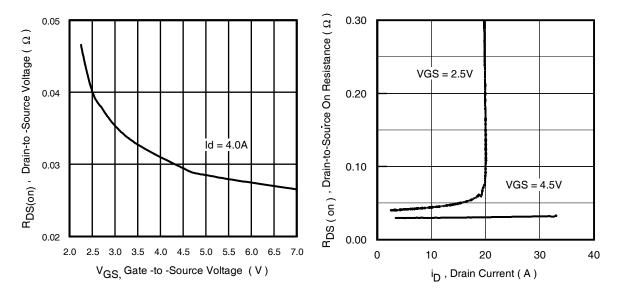


Fig 11. On-Resistance Vs. Gate Voltage

Fig 12. On-Resistance Vs. Drain Current

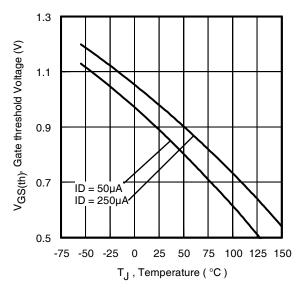
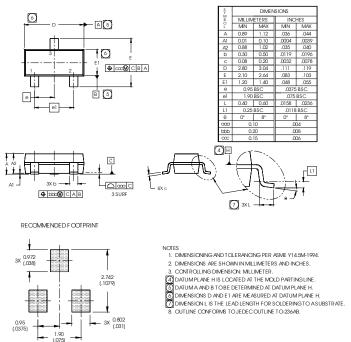


Fig 13. Threshold Voltage Vs. Temperature



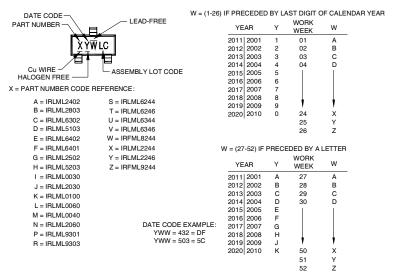
Micro3 (SOT-23) (Lead-Free) Package Outline

Dimensions are shown in millimeters (inches)



Micro3 (SOT-23 / TO-236AB) Part Marking Information

Notes: This part marking information applies to devices produced after 02/26/2001

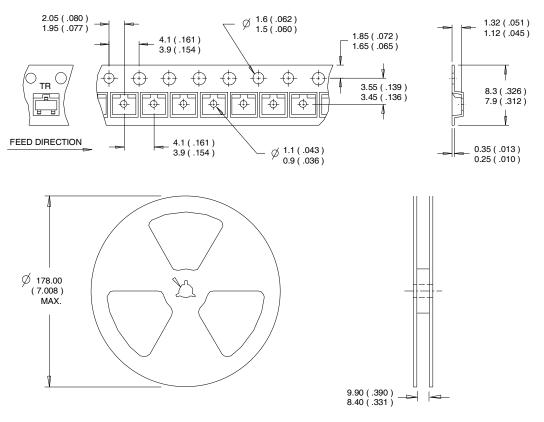


Note: For the most current drawing please refer to IR website at http://www.irf.com/package



Micro3™ Tape & Reel Information

Dimensions are shown in millimeters (inches)



NOTES:

- 1. CONTROLLING DIMENSION : MILLIMETER.
- 2. OUTLINE CONFORMS TO EIA-481 & EIA-541.

Note: For the most current drawing please refer to IR website at http://www.irf.com/package



Qualification information[†]

Qualification level	Consumer (per JEDEC JESD47F ^{††} guidelines)			
Moisture Sensitivity Level	Micro3™ (SOT-23) MSL1 (per JEDEC J-STD-020D ^{††})			
RoHS compliant	Yes			

- † Qualification standards can be found at International Rectifier's web site: http://www.irf.com/product-info/reliability
- †† Applicable version of JEDEC standard at the time of product release

Revision History

Date	Comment				
	Updated data sheet with new IR corporate template.				
4/04/0044	Updated package outline & part marking on page 7.				
4/24/2014	Added Qualification table -Qual level "Consumer" on page 9.				
	Added bullet point in the Benefits "RoHS Compliant, Halogen -Free" on page 1.				



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